BB17F

KDS Bump bar

HENGYU

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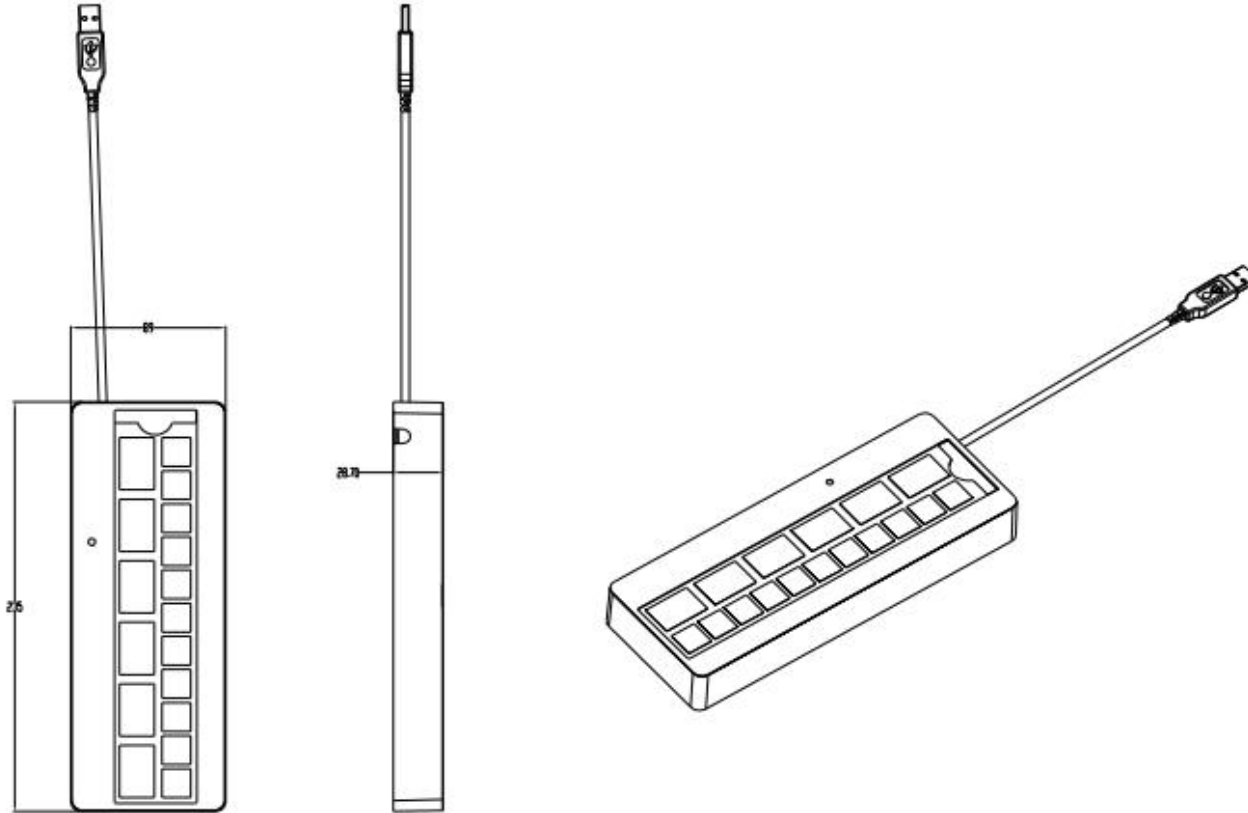| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | REDRAW |

BB17F
KDS Bump bar

HENGYU

Main Features

- Housing made of industrial plastic, strong and robust

- With 20 metal domes on top of sealed flat panel membrane

- Spill proof design on the top surface

- Easy to extrac the paper legend out of the pocket for change

- Detachable cable with RJ45 plug, easy to be replaced

- All keys are programmable, support firmware upgrade

- USB interface is available

Technical Specification

[Electronics]

USB interface

Power supply: +5V/DC ±5%

Current input: < 100mA

MTBF: 50,000 hours

[Mechanical]

Total travel: 1 – 0.2mm

Peak load before make: 14 - 16 Oz

[Others]

Storage temperature: -40˚C to +60˚C

Operating temperature: 0˚C to +50˚C

Operating humidity: 20% to 90%

Dimensions: 235 x68 x 28.7 mm

- Heng Yu Technology (HK) Limited
- http://www.hengyu-tech.com